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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	ARM® Cortex®-M4F
Core Size	32-Bit Single-Core
Speed	180MHz
Connectivity	CANbus, CSIO, EBI/EMI, Ethernet, I²C, LINbus, SD, SmartCard, SPI, UART/USART, USB
Peripherals	DMA, I²S, LVD, POR, PWM, WDT
Number of I/O	121
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 24x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/s6e2gm6hhagv2000a

3. Package-Dependent Features

All S6E2G Series of parts are available in both 144-pin LQFP and 176-pin LQFP.

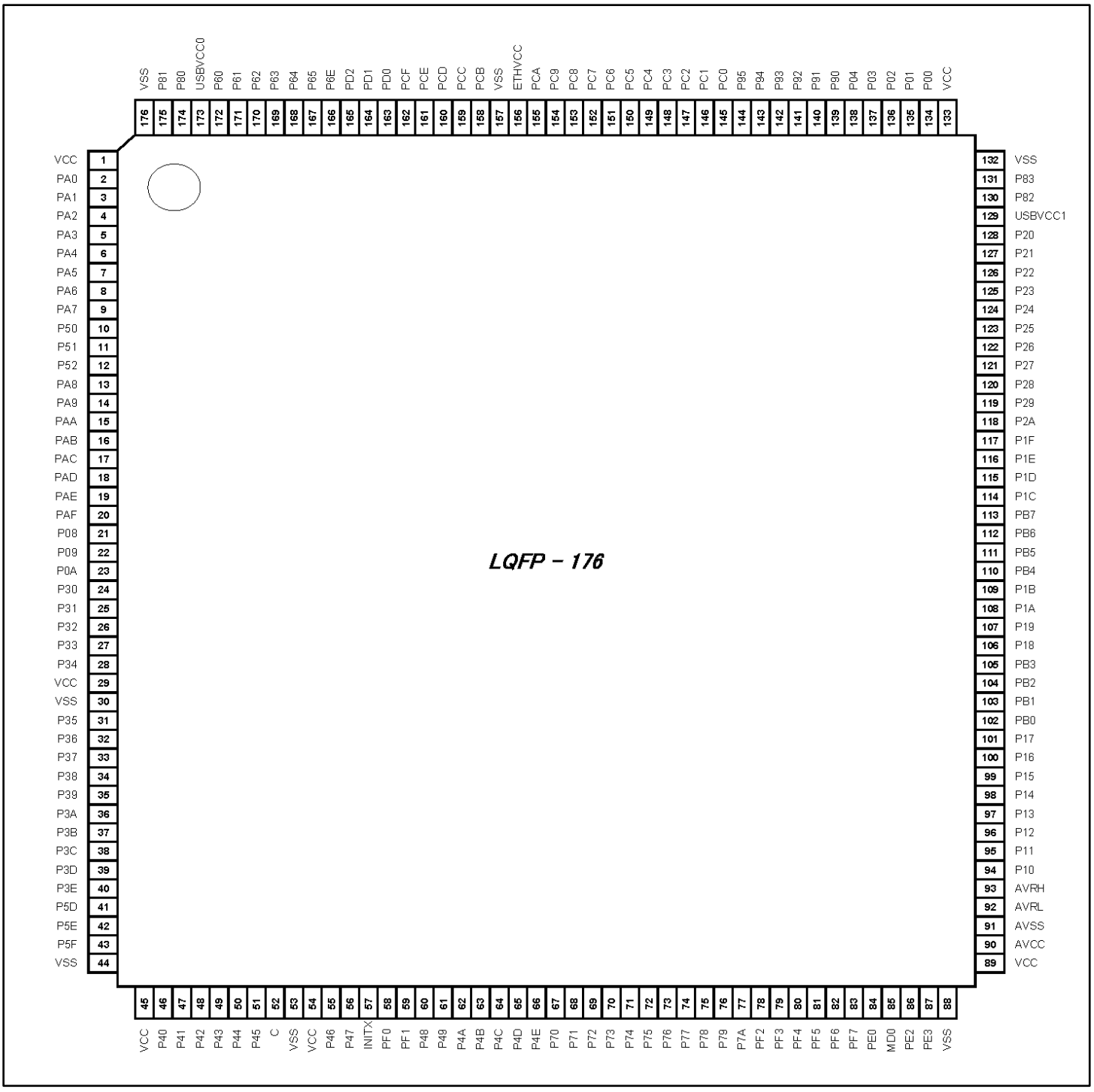
Description	Base Part Number S6E2G			
	Package Suffix			
	H0A	HHA*	J0A	JHA*
LQFP: (0.5 mm pitch)	144 pins		176 pins	
I/O Ports	121 pins (Max)		153 pins (Max)	
12-bit ADC converter	24 (3 units)		32 ch (3 units)	
Crypto Assist Function	—	Yes	—	Yes

*HHA and JHA parts have the Crypto Assist Function built in. HHA and JHA options are not available for the S6E2GH or S6E2G3 parts. The HHA and JHA options are available on the S6E2GM, S6E2GK, and S6E2G2 parts.

Notes:

- *For an explicit list of part numbers and the feature differences among them, see 13. Ordering Information*
- *See 14. Package Dimensions for detailed information on each package.*

LQP176



Note:

- *Only the GPIO function is shown on GPIO pins. See the table in Pin Descriptions for the full, multiplexed signal name.*

Pin Number		Pin Name	I/O Circuit Type	Pin State Type
LQFP-176	LQFP-144			
38	33	P3C SIN2_1 RTO03_0 (PPG03_0) TIOA3_1 INT19_1 MAD21_0	G	K
39	34	P3D SOT2_1 (SDA2_1) RTO04_0 (PPG04_0) TIOA4_1 MAD20_0	G	I
40	35	P3E SCK2_1 (SCL2_1) RTO05_0 (PPG05_0) TIOA5_1 MAD19_0	G	I
41	-	P5D SIN1_1 MI2SDI1_1 TIOB12_2 INT03_2	E	K
42	-	P5E SOT1_1 (SDA1_1) MI2SDO1_1 TIOA13_2	E	I
43	-	P5F SCK1_1 (SCL1_1) MI2SCK1_1 TIOB13_2	E	I
44	36	VSS	-	-
45	37	VCC	-	-
46	38	P40 SIN7_1 RTO10_0 (PPG10_0) TIOA0_0 AIN0_0 INT23_0 MCSX7_0	G	K

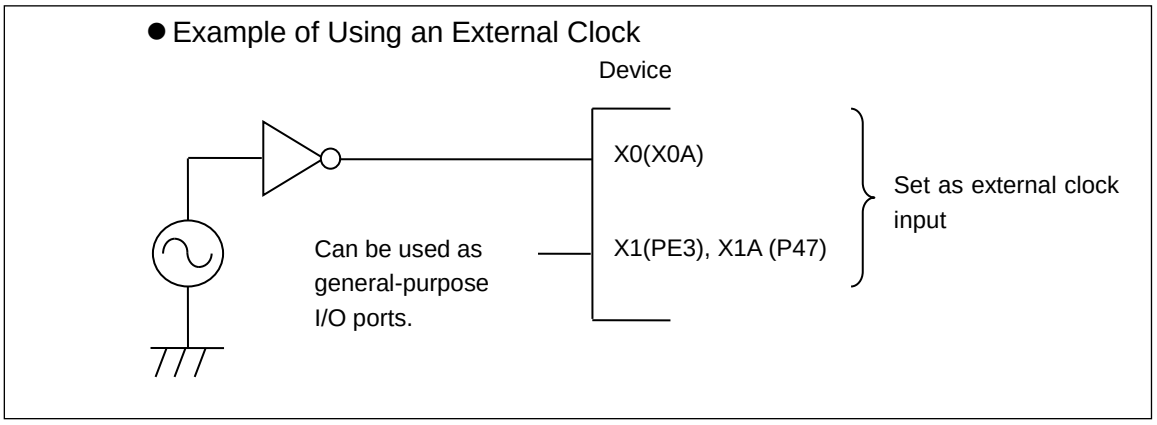
Pin Number		Pin Name	I/O Circuit Type	Pin State Type
LQFP-176	LQFP-144			
112	-	PB6	F	N
		AN22		
		SOT8_1 (SDA8_1)		
		TIOA12_1		
		BIN1_2		
		TRACED14		
113	-	PB7	F	N
		AN23		
		SCK8_1 (SCL8_1)		
		TIOB12_1		
		ZIN1_2		
		TRACED15		
114	90	P1C	F	N
		AN12		
		SCK0_1 (SCL0_1)		
		TIOA5_2		
		TRACECLK		
115	91	P1D	F	L
		AN13		
		SOT0_1 (SDA0_1)		
		TIOB5_2		
		MAD09_0		
116	92	P1E	F	M
		AN14		
		SIN0_1		
		TIOA8_1		
		INT26_1		
		MAD10_0		
117	93	P1F	F	M
		AN15		
		RTS5_0		
		TIOB8_1		
		INT27_1		
		MAD11_0		
118	94	P2A	F	M
		AN24		
		CTS5_0		
		INT08_2		
		MAD12_0		

Pin Number		Pin Name	I/O Circuit Type	Pin State Type
LQFP-176	LQFP-144			
141	-	P92	E	K
		SOT5_1 (SDA5_1)		
		RTO12_1 (PPG12_1)		
		TIOB2_1		
		INT14_1		
		IC0_VPEN_1		
142	-	P93	E	K
		SCK5_1 (SCL5_1)		
		RTO13_1 (PPG13_1)		
		TIOB3_1		
		INT15_1		
		IC0_RST_1		
143	-	P94	E	I
		CTS5_1		
		RTO14_1 (PPG14_1)		
		TIOB4_1		
		IC0_DATA_1		
144	-	P95	E	I
		RTS5_1		
		RTO15_1 (PPG15_1)		
		TIOB5_1		
		IC0_CIN_1		
145	115	PC0	K	V
		E_RXER		
146	116	PC1	K	V
		TIOB6_0		
		E_RX03		
147	117	PC2	K	V
		TIOA6_0		
		E_RX02		
148	118	PC3	K	V
		TIOB7_0		
		E_RX01		
149	119	PC4	K	V
		TIOA7_0		
		E_RX00		
150	120	PC5	K	V
		TIOB14_0		
		E_RXDV		

Module	Pin Name	Function	Pin Number	
			LQFP 176	LQFP 144
GPIO	P70	General-purpose I/O port 7	67	57
	P71		68	58
	P72		69	59
	P73		70	60
	P74		71	61
	P75		72	62
	P76		73	63
	P77		74	64
	P78		75	65
	P79		76	66
	P7A		77	67
	P80	General-purpose I/O port 8	174	142
	P81		175	143
	P82		130	106
	P83		131	107
	P90	General-purpose I/O port 9	139	-
	P91		140	-
	P92		141	-
	P93		142	-
	P94		143	-
	P95		144	-
	PA0	General-purpose I/O port A	2	2
	PA1		3	3
	PA2		4	4
	PA3		5	5
	PA4		6	6
	PA5		7	7
	PA6		8	8
	PA7		9	9
	PA8		13	10
	PA9		14	11
	PAA		15	12
	PAB		16	13
	PAC		17	14
	PAD		18	15
	PAE		19	16
	PAF		20	17

Using an External Clock

When using an external clock as an input of the main clock, set X0/X1 to the external clock input, and input the clock to X0. X1(PE3) can be used as a general-purpose I/O port. Similarly, when using an external clock as an input of the sub clock, set X0A/X1A to the external clock input and input the clock to X0A. X1A (P47) can be used as a general-purpose I/O port.

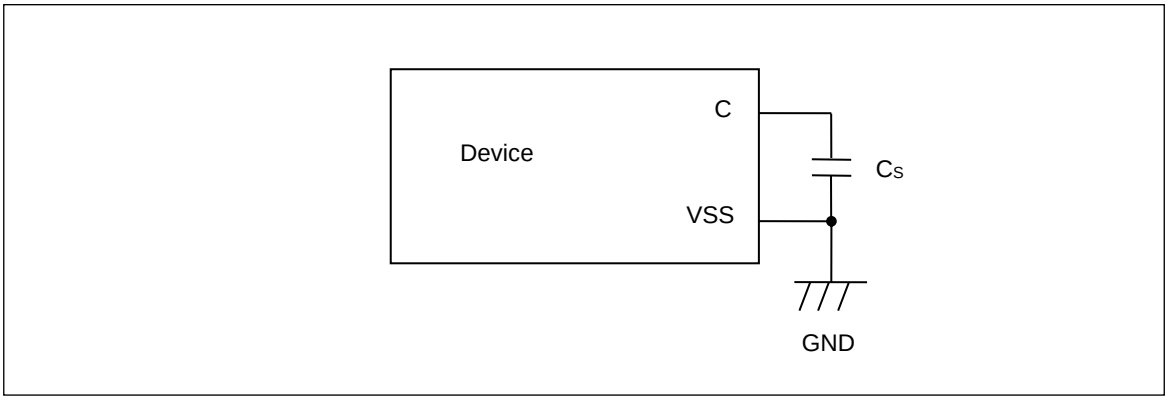


Handling When Using Multi-Function Serial Pin as I²C Pin

If the application uses the multi-function serial pin as an I²C pin, the P-channel transistor of the digital output must be disabled. I²C pins need to conform to electrical limitations like other pins, however, and avoid connecting to live external systems with the MCU power off.

C Pin

Devices in this series contain a regulator. Be sure to connect a smoothing capacitor (C_S) for the regulator between the C pin and the GND pin. Please use a ceramic capacitor or a capacitor of equivalent frequency characteristics as a smoothing capacitor. Some laminated ceramic capacitors have a large capacitance variation due to thermal fluctuation. Please select a capacitor that meets the specifications in the operating conditions to use by evaluating the temperature characteristics of the device. A smoothing capacitor of about 4.7 µF would be recommended for this series.

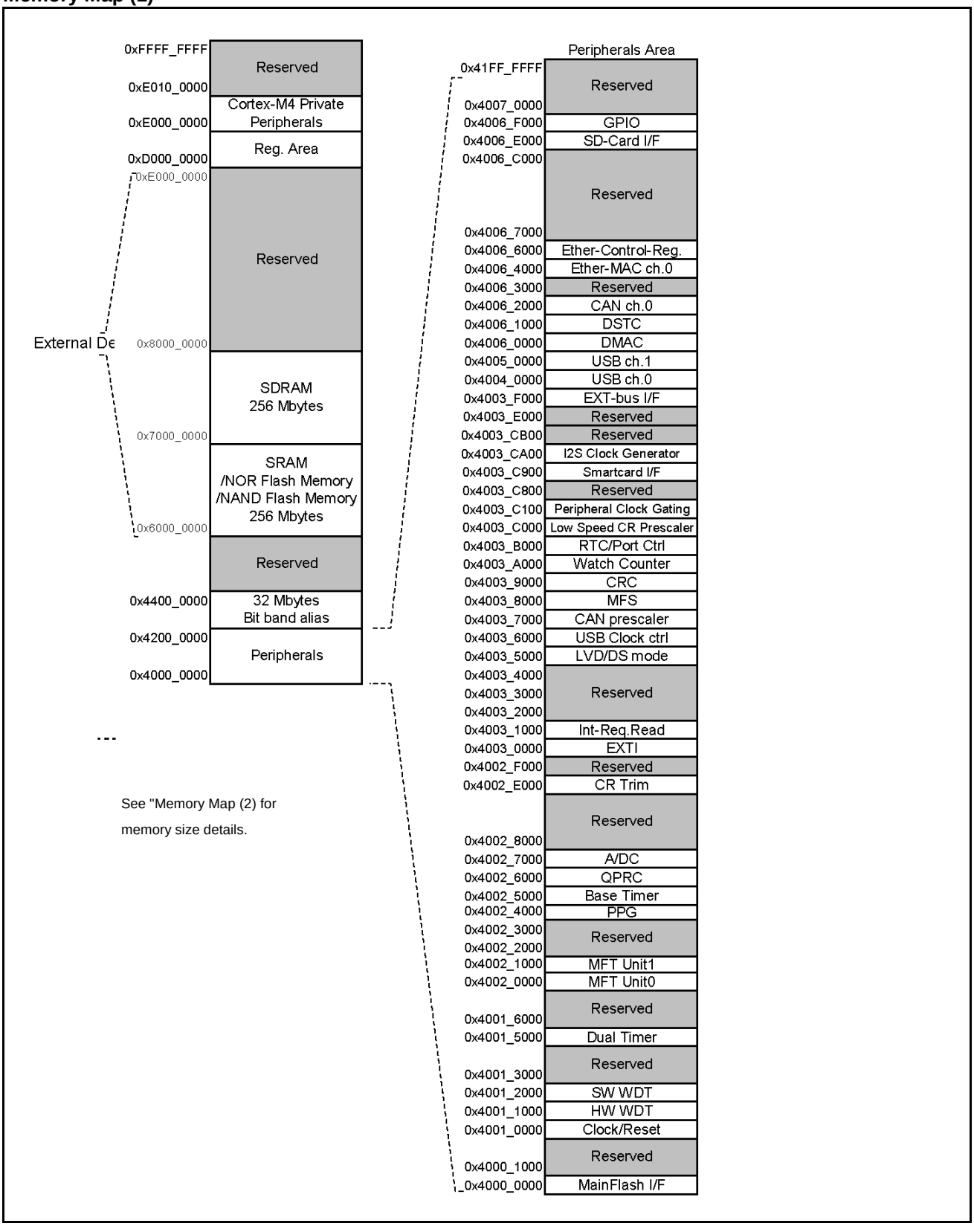


Mode Pins (MD0)

Connect the MD pin (MD0) directly to VCC or VSS pins. Design the printed circuit board such that the pull-up/down resistance stays low, the distance between the mode pins and VCC pins or VSS pins is as short as possible, and the connection impedance is low when the pins are pulled up/down such as for switching the pin level and rewriting the flash memory data. This is important to prevent the device from erroneously switching to test mode as a result of noise.

10. Memory Map

Memory Map (1)



Peripheral Address Map

Start Address	End Address	Bus	Peripherals
0x4000_0000	0x4000_0FFF	AHB	MainFlash I/F register
0x4000_1000	0x4000_FFFF		Reserved
0x4001_0000	0x4001_0FFF	APB0	Clock/reset control
0x4001_1000	0x4001_1FFF		Hardware watchdog timer
0x4001_2000	0x4001_2FFF		Software watchdog timer
0x4001_3000	0x4001_4FFF		Reserved
0x4001_5000	0x4001_5FFF		Dual-timer
0x4001_6000	0x4001_FFFF		Reserved
0x4002_0000	0x4002_0FFF	APB1	Multi-Function Timer unit 0
0x4002_1000	0x4002_1FFF		Multi-Function Timer unit 1
0x4002_2000	0x4002_3FFF		Reserved
0x4002_4000	0x4002_4FFF		PPG
0x4002_5000	0x4002_5FFF		Base timer
0x4002_6000	0x4002_6FFF		Quadrature position/revolution counter
0x4002_7000	0x4002_7FFF		A/D converter
0x4002_8000	0x4002_DFFF		Reserved
0x4002_E000	0x4002_EFFF		Internal CR trimming
0x4002_F000	0x4002_FFFF		Reserved
0x4003_0000	0x4003_0FFF	APB2	External interrupt controller
0x4003_1000	0x4003_1FFF		Interrupt request batch-read function
0x4003_2000	0x4003_4FFF		Reserved
0x4003_5000	0x4003_57FF		Low voltage detector
0x4003_5800	0x4003_5FFF		Deep standby mode Controller
0x4003_6000	0x4003_6FFF		USB clock generator
0x4003_7000	0x4003_7FFF		CAN prescaler
0x4003_8000	0x4003_8FFF		Multi-function serial interface
0x4003_9000	0x4003_9FFF		CRC
0x4003_A000	0x4003_AFFF		Watch counter
0x4003_B000	0x4003_BFFF		RTC/port control
0x4003_C000	0x4003_C0FF		Low-speed CR prescaler
0x4003_C100	0x4003_C7FF		Peripheral clock gating
0x4003_C800	0x4003_C8FF		Reserved
0x4003_C900	0x4003_C9FF		I2S clock generator
0x4003_CA00	0x4003_CAFF		Smartcard Interface
0x4003_CB00	0x4003_EFFF		Reserved
0x4003_F000	0x4003_FFFF		External memory interface

Pin Status Type	Function Group	Power-On Reset or Low-Voltage Detection State	INITX Input State	Device Internal Reset State	Run mode or Sleep mode State	Timer mode, RTC mode, or Stop mode State		Deep Standby RTC mode or Deep Standby Stop mode State		Return from Deep Standby mode State
		Power Supply Unstable	Power Supply Stable		Power Supply Stable	Power Supply Stable		Power Supply Stable		Power Supply Stable
		-	INITX=0	INITX=1	INITX=1	INITX=1		INITX=1		INITX=1
		-	-	-	-	SPL=0	SPL=1	SPL=0	SPL=1	-
J	Analog output selected	Hi-Z	Hi-Z/ input enabled	Hi-Z/ input enabled	Maintain previous state	*2	*3	GPIO selected, internal input fixed at 0	Hi-Z/internal input fixed at 0	GPIO selected
	External interrupt enable selected					Maintain previous state	Maintain previous state			
	Resource other than above selected						Hi-Z/internal input fixed at 0			
	GPIO selected									
K	External interrupt enable selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Maintain previous state	GPIO selected, internal input fixed at 0	Hi-Z/internal input fixed at 0	GPIO selected
	Resource other than above selected	Hi-Z	Hi-Z/ input enabled	Hi-Z/ input enabled			Hi-Z/internal input fixed at 0			
	GPIO selected									
L	Analog input selected	Hi-Z	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled
	Resource other than above selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Hi-Z/internal input fixed at 0	GPIO selected, internal input fixed at 0	Hi-Z/internal input fixed at 0	GPIO selected
	GPIO selected									

Table 12-2 Typical and Maximum Current Consumption in Normal Operation (PLL), Code with Data Accessing Running from Flash Memory (Flash Accelerator Mode and Trace Buffer Function Disabled)

Parameter	Symbol	Pin Name	Conditions		Frequency*4	Value		Unit	Remarks
						Typ*1	Max*2		
Power supply current	I_{CC}	VCC	Normal operation *7,*8 (PLL)	*5	180 MHz	82	140	mA	*3 When all peripheral clocks are on
				*6	160 MHz	74	132	mA	
					144 MHz	68	126	mA	
					120 MHz	58	116	mA	
					100 MHz	49	107	mA	
					80 MHz	40	98	mA	
					60 MHz	31	89	mA	
					40 MHz	22	80	mA	
					20 MHz	13	71	mA	
					8 MHz	7.5	65	mA	
					4 MHz	5.6	63	mA	
				*5	180 MHz	48	106	mA	*3 When all peripheral clocks are off
				*6	160 MHz	44	102	mA	
					144 MHz	41	99	mA	
					120 MHz	35	93	mA	
					100 MHz	30	88	mA	
					80 MHz	25	83	mA	
					60 MHz	20	78	mA	
					40 MHz	14	72	mA	
					20 MHz	8.7	66	mA	
					8 MHz	5.6	63	mA	
					4 MHz	4.5	62	mA	

1: T_A = +25 °C, V_{CC} = 3.3 V

2: T_J = +125 °C, V_{CC} = 5.5 V

3: When all ports are input and are fixed at 0

4: Frequency is a value of HCLK when PCLK0 = PCLK1 = PCLK2 = HCLK

5: When stopping flash accelerator mode and trace buffer function (FRWTR.RWT = 11, FBFCR.BE = 0)

6: When stopping flash accelerator mode and trace buffer function (FRWTR.RWT = 10, FBFCR.BE = 0)

7: With data access to a MainFlash memory.

8: When using the crystal oscillator of 4 MHz (including the current consumption of the oscillation circuit)

Table 12-6 Typical and Maximum Current Consumption in Sleep Operation (PLL), when PCLK0 = PCLK1 = PCLK2 = HCLK

Parameter	Symbol	Pin Name	Conditions	Frequency*4	Value		Unit	Remarks
					Typ*1	Max*2		
Power supply current	I_{CCS}	VCC	Sleep operation*5 (PLL)	72 MHz	32	90	mA	*3 When all peripheral clocks are on
				60 MHz	27	85	mA	
				48 MHz	23	81	mA	
				36 MHz	18	76	mA	
				24 MHz	13	71	mA	
				12 MHz	8.5	66	mA	
				8 MHz	6.9	64	mA	
				4 MHz	5.3	63	mA	
				72 MHz	15	73	mA	*3 When all peripheral clocks are off
				60 MHz	13	71	mA	
				48 MHz	11	69	mA	
				36 MHz	9.3	67	mA	
				24 MHz	7.3	65	mA	
				12 MHz	5.4	63	mA	
				8 MHz	4.7	62	mA	
				4 MHz	4.1	62	mA	

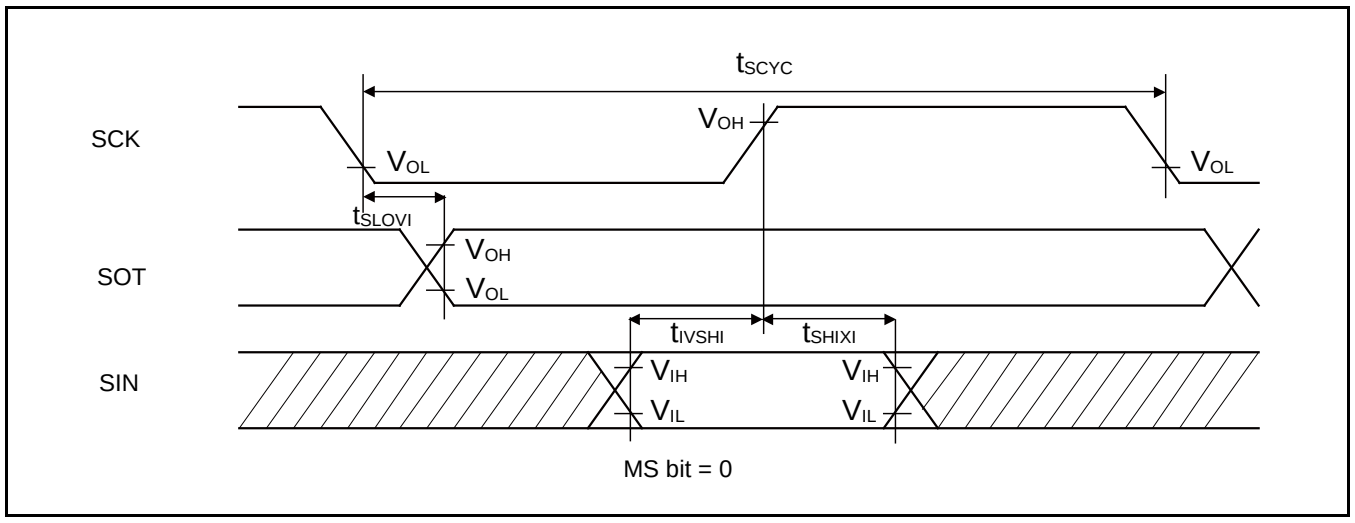
1: T_A = +25 °C, V_{CC} = 3.3 V

2: T_J = +125 °C, V_{CC} = 5.5 V

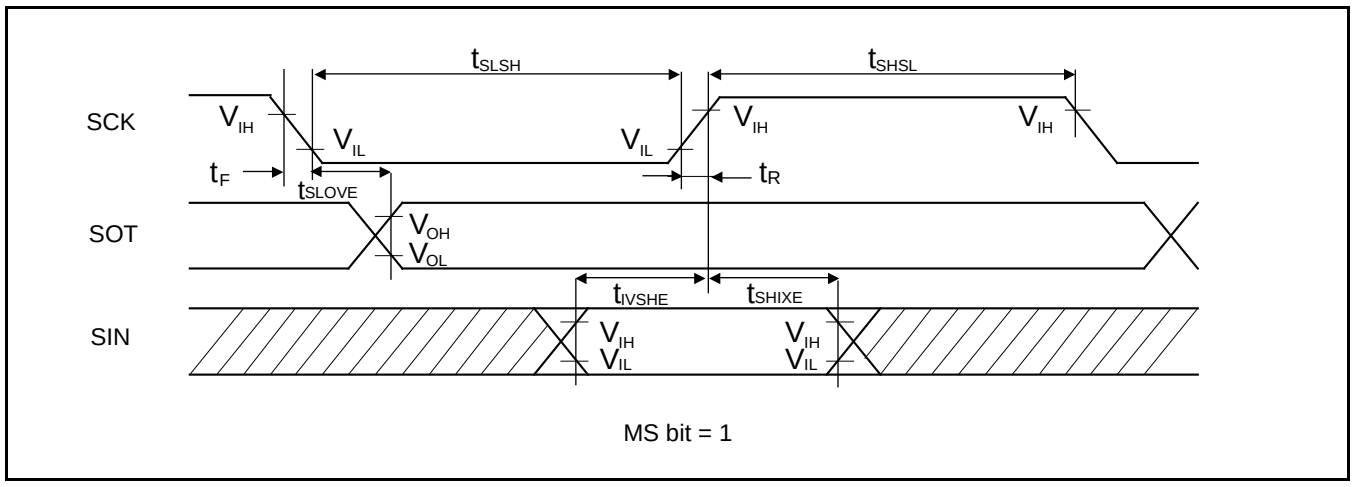
3: When all ports are input and are fixed at 0

4: Frequency is a value of HCLK when PCLK0 = PCLK1 = PCLK2 = HCLK

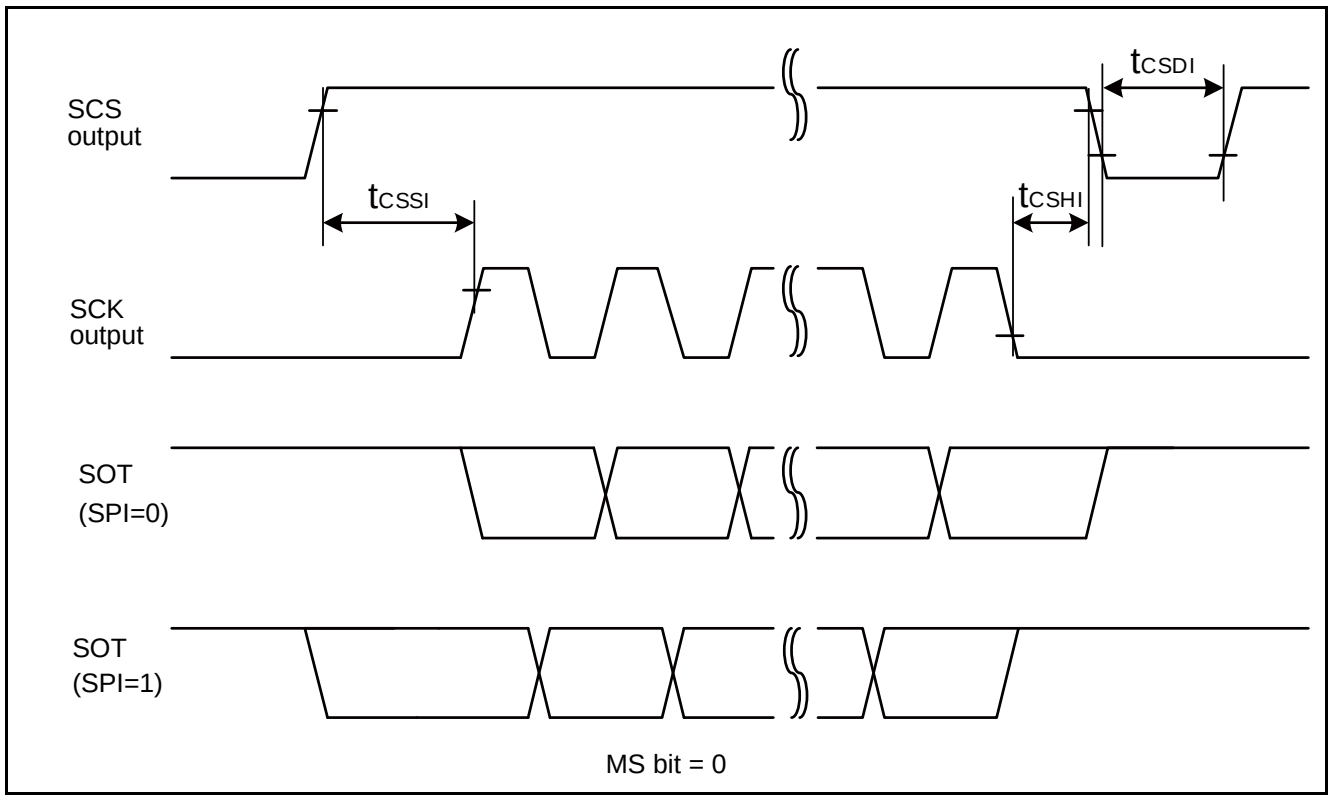
5: When using the crystal oscillator of 4 MHz (including the current consumption of the oscillation circuit)



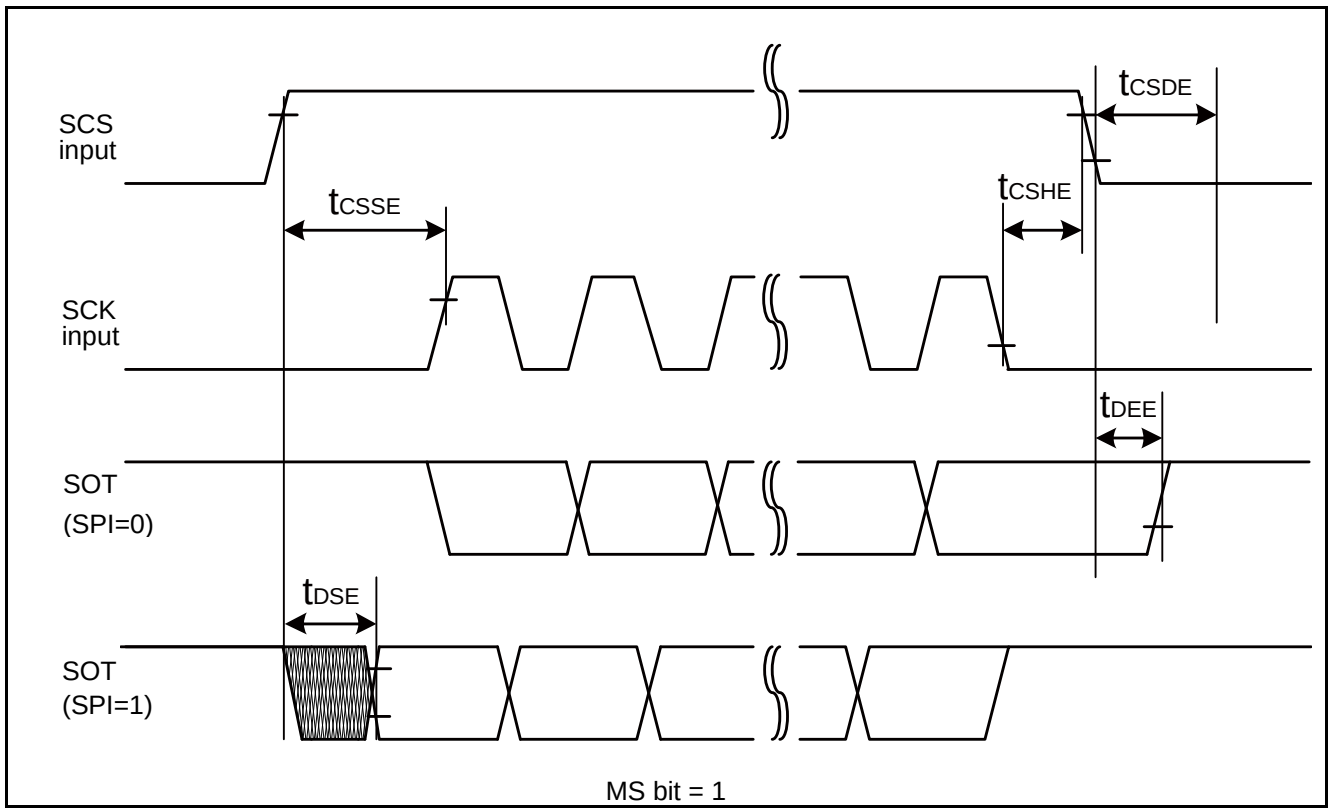
MS bit = 0



MS bit = 1



MS bit = 0



MS bit = 1

High-Speed Synchronous Serial (SPI = 0, SCINV = 0)

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V)

Parameter	Symbol	Pin Name	Conditions	V_{CC} < 4.5 V		V_{CC} ≥ 4.5 V		Unit
				Min	Max	Min	Max	
Serial clock cycle time	t_{SCYC}	SCKx	Internal shift clock operation	$4t_{CYCP}$	-	$4t_{CYCP}$	-	ns
SCK↓→SOT delay time	t_{SLOVI}	SCKx, SOTx		- 10	+ 10	- 10	+ 10	ns
SIN→SCK↑ setup time	t_{IVSHI}	SCKx, SINx		14 12.5*	-	12.5	-	ns
SCK↑→SIN hold time	t_{SHIXI}	SCKx, SINx		5	-	5	-	ns
Serial clock L pulse width	t_{SLSH}	SCKx	External shift clock operation	$2t_{CYCP}$ - 5	-	$2t_{CYCP}$ - 5	-	ns
Serial clock H pulse width	t_{SHSL}	SCKx		t_{CYCP} + 10	-	t_{CYCP} + 10	-	ns
SCK↓→SOT delay time	t_{SLOVE}	SCKx, SOTx		-	15	-	15	ns
SIN→SCK↑ setup time	t_{IVSHE}	SCKx, SINx		5	-	5	-	ns
SCK↑→SIN hold time	t_{SHIXE}	SCKx, SINx		5	-	5	-	ns
SCK fall time	t_F	SCKx		-	5	-	5	ns
SCK rise time	t_R	SCKx		-	5	-	5	ns

Notes:

- *The above characteristics apply to CLK synchronous mode.*
- *t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 1. S6E2G Series Block Diagram in this data sheet.*
- *These characteristics only guarantee the following pins:*

  No chip select: SIN4_0, SOT4_0, SCK4_0

  Chip select: SIN6_0, SOT6_0, SCK6_0, SCS60_0, SCS61_0, SCS62_0, SCS63_0
- *When the external load capacitance C_L = 30 pF. (For *, when C_L = 10 pF)*

High-Speed Synchronous Serial (SPI = 1, SCINV = 0)

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V)

Parameter	Symbol	Pin Name	Conditions	V_{CC} < 4.5 V		V_{CC} ≥ 4.5 V		Unit
				Min	Max	Min	Max	
Serial clock cycle time	t_{SCYC}	SCKx	Internal shift clock operation	$4t_{CYCP}$	-	$4t_{CYCP}$	-	ns
SCK↑→SOT delay time	t_{SHOVI}	SCKx, SOTx		- 10	+ 10	- 10	+ 10	ns
SIN→SCK↓ setup time	t_{IVSLI}	SCKx, SINx		14 12.5*	-	12.5	-	ns
SCK↓→SIN hold time	t_{SLIXI}	SCKx, SINx		5	-	5	-	ns
SOT→SCK↓ delay time	t_{SOVLI}	SCKx, SOTx		$2t_{CYCP}$ - 10	-	$2t_{CYCP}$ - 10	-	ns
Serial clock L pulse width	t_{SLSH}	SCKx	External shift clock operation	$2t_{CYCP}$ - 5	-	$2t_{CYCP}$ - 5	-	ns
Serial clock H pulse width	t_{SHSL}	SCKx		t_{CYCP} + 10	-	t_{CYCP} + 10	-	ns
SCK↑→SOT delay time	t_{SHOVE}	SCKx, SOTx		-	15	-	15	ns
SIN→SCK↓ setup time	t_{IVSLE}	SCKx, SINx		5	-	5	-	ns
SCK↓→SIN hold time	t_{SLIXE}	SCKx, SINx		5	-	5	-	ns
SCK fall time	t_F	SCKx		-	5	-	5	ns
SCK rise time	t_R	SCKx		-	5	-	5	ns

Notes:

- *The above characteristics apply to CLK synchronous mode.*
- *t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 1. S6E2G Series Block Diagram in this data sheet.*
- *These characteristics only guarantee the following pins:*

  No chip select: SIN4_0, SOT4_0, SCK4_0

  Chip select: SIN6_0, SOT6_0, SCK6_0, SCS60_0, SCS61_0, SCS62_0, SCS63_0
- *When the external load capacitance C_L = 30 pF. (for *, when C_L = 10 pF)*

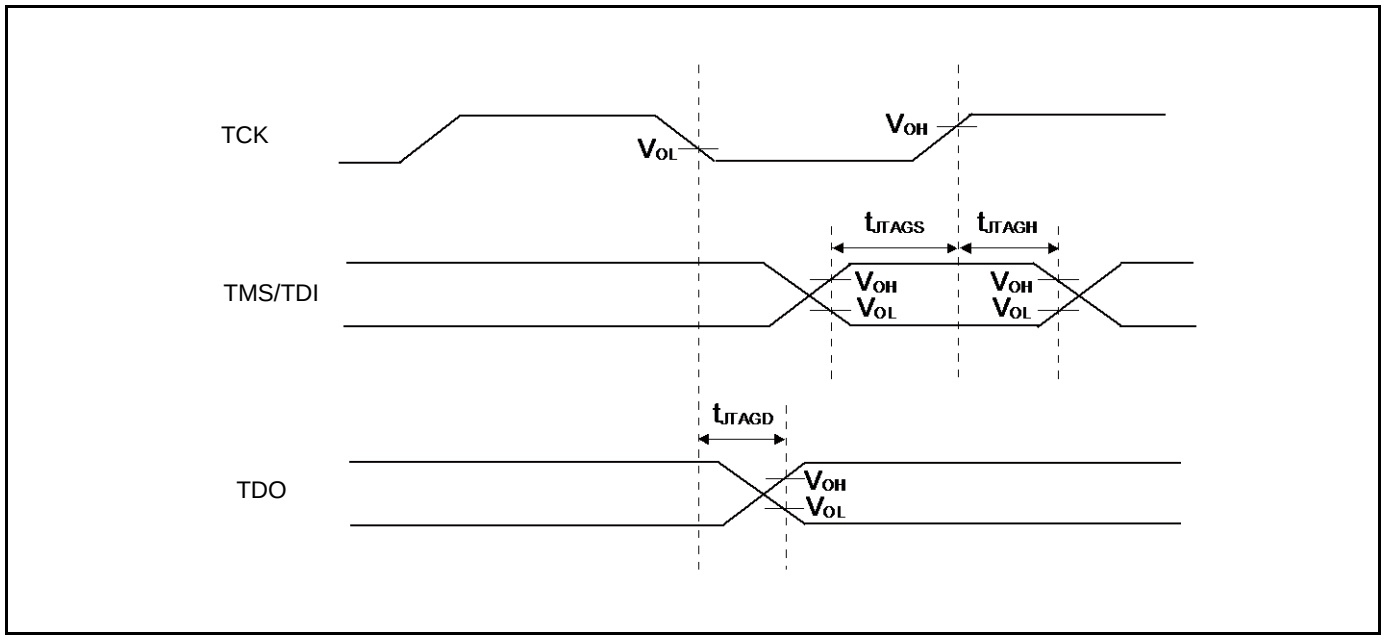
12.4.18 JTAG Timing

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V)

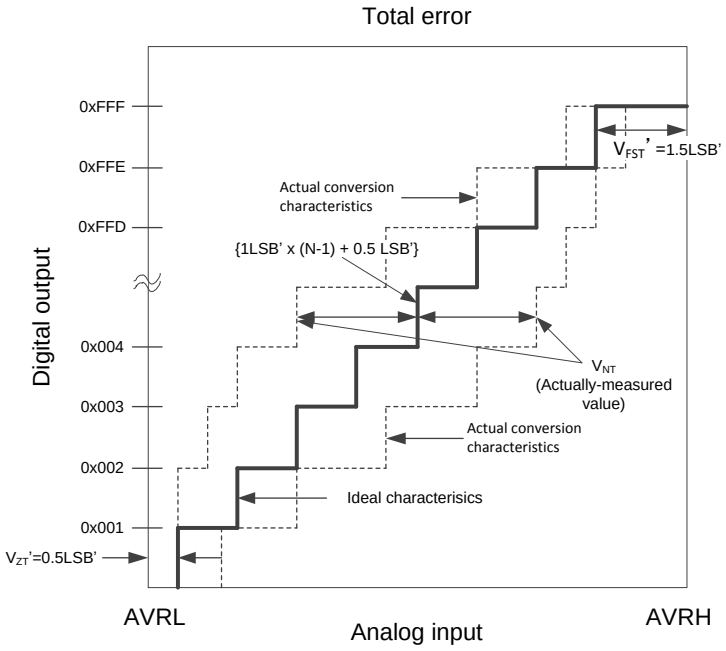
Parameter	Symbol	Pin Name	Conditions	Value		Unit	Remarks
				Min	Max		
TMS, TDI setup time	t_{JTAGS}	TCK, TMS, TDI	$V_{CC} \geq 4.5$ V	15	-	ns	
			$V_{CC} < 4.5$ V				
TMS, TDI hold time	t_{JTAGH}	TCK, TMS, TDI	$V_{CC} \geq 4.5$ V	15	-	ns	
			$V_{CC} < 4.5$ V				
TDO delay time	t_{JTAGD}	TCK, TDO	$V_{CC} \geq 4.5$ V	-	25	ns	
			$V_{CC} < 4.5$ V	-	45		

Note:

- *When the external load capacitance C_L = 30 pF.*



■ Total error: A difference between actual value and theoretical value.
The overall error includes zero-transition voltage, full-scale transition voltage and linearity error.



$$\text{Total error of digital output N} = \frac{V_{NT} - \{1\ LSB' \times (N-1) + 0.5\ LSB'\}}{1\ LSB'} \quad [LSB]$$

$$1\ LSB'\ (\text{ideal value}) = \frac{AVRH - AVRL}{4096} \quad [V]$$

V_{ZT}' (ideal value) = AVRL + 0.5 LSB' [V]

V_{FST}' (ideal value) = AVRH - 1.5 LSB' [V]

V_{NT}': A voltage for causing transition of digital output from (N-1) to N

12.9.2 Recovery Cause: Reset

The time from reset release to the program operation start is shown.

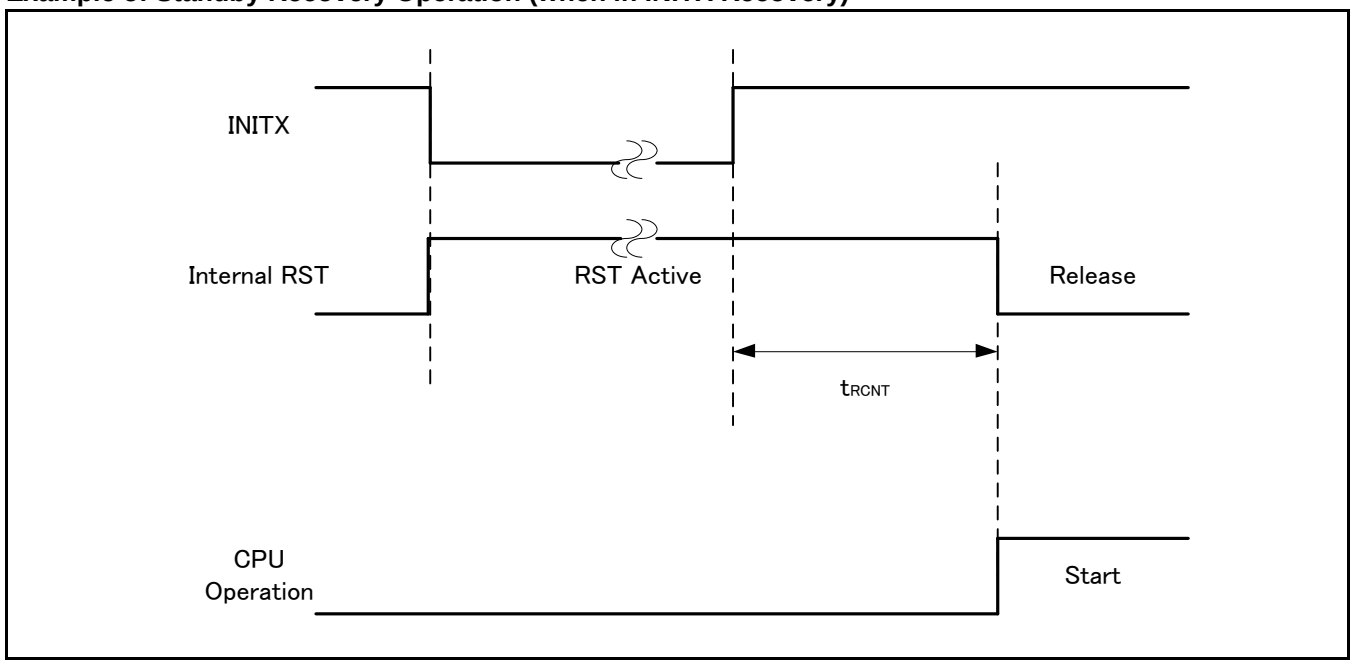
Recovery Count Time

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V)

Parameter	Symbol	Value		Unit	Remarks
		Typ	Max*		
Sleep mode	t_{RCNT}	155	266	µs	
High-speed CR Timer mode Main Timer mode PLL Timer mode		155	266	µs	
Low-speed CR Timer mode		315	567	µs	
Sub Timer mode		315	567	µs	
RTC mode Stop mode		315	567	µs	
Deep Standby RTC mode with RAM retention		336	667	µs	without RAM retention
Deep Standby Stop mode with RAM retention		336	667	µs	with RAM retention

*: The maximum value depends on the built-in CR accuracy.

Example of Standby Recovery Operation (when in INITX Recovery)



Revision	ECN	Orig. of Change	Submission Date	Description of Change
				S6E2GM6JHAGV20000, S6E2GM8H0AGV20000, S6E2GM8HHAGV20000, S6E2GM8J0AGV20000, S6E2GM8JHAGV20000 Added MPNs below to “13. Ordering Information” (Page 185) S6E2G26H0AGV2000A, S6E2G26HHAGV2000A, S6E2G26J0AGV2000A, S6E2G26JHAGV2000A, S6E2G28H0AGV2000A, S6E2G28HHAGV2000A, S6E2G28J0AGV2000A, S6E2G28JHAGV2000A, S6E2G36H0AGV2000A, S6E2G36J0AGV2000A, S6E2G38H0AGV2000A, S6E2G38J0AGV2000A, S6E2GH6H0AGV2000A, S6E2GH6J0AGV2000A, S6E2GH8H0AGV2000A, S6E2GH8J0AGV2000A, S6E2GK6H0AGV2000A, S6E2GK6HHAGV2000A, S6E2GK6J0AGV2000A, S6E2GK6JHAGV2000A, S6E2GK8H0AGV2000A, S6E2GK8HHAGV2000A, S6E2GK8J0AGV2000A, S6E2GK8JHAGV2000A, S6E2GM6H0AGV2000A, S6E2GM6HHAGV2000A, S6E2GM6J0AGV2000A, S6E2GM6JHAGV2000A, S6E2GM8H0AGV2000A, S6E2GM8HHAGV2000A, S6E2GM8J0AGV2000A, S6E2GM8JHAGV2000A Modified typo about the munber of QPRC channels(from 4ch to 2ch) (Page 1,6,10) Modified the expression of the “Built-in CR” in “2. Product Lineup”(Page 6).